

General Description

Ultra-FRD module devices are optimized to reduce losses and EMI/RFI in high frequency power conditioning electrical systems.

These diode modules are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

Features

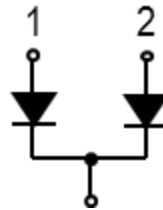
- Repetitive Reverse Voltage : $V_{RRM} = 400V$
- Low Forward Voltage : $V_F(\text{typ.}) = 1.0V$
- Average Forward Current : $I_F(\text{Av.}) = 100A @ T_C = 100^\circ C$
- Ultra-Fast Reverse Recovery Time : $t_{rr}(\text{typ.}) = 35ns$
- Extensive Characterization of Recovery Parameters
- Reduced EMI and RFI
- Non Isolation Type Package
- $175^\circ C$ Operating Junction Temperature
- Dual FRD Construction

Applications

- High Speed & High Power converters, Welders
- Various Switching and Telecommunication Power Supply



3DM-2NI



(Common Heat Sink)

Absolute Maximum Ratings @ $T_C = 25^\circ C$ (Per Leg)

Characteristics	Conditions	Symbol	Rating	Unit	
Repetitive Peak Reverse Voltage		V_{RRM}	400	V	
Reverse DC Voltage		$V_{R(DC)}$	320	V	
Average Forward Current	Resistive Load	$I_{F(AV)}$	$T_C = 25^\circ C$	200	A
			$T_C = 100^\circ C$	100	A
Surge(non-repetitive) Forward Current	One Half Cycle at 60Hz, Peak Value	I_{FSM}	2000	A	
I^2t for Fusing	Value for One Cycle Current, $t_w = 8.3ms, T_J = 25^\circ C$ Start	I^2t	16.7×10^3	A^2s	
Junction Temperature		T_J	-40 ~ 175	$^\circ C$	
Maximum Power Dissipation		P_D	480	W	
Storage Temperature		T_{stg}	-40 ~ 150	$^\circ C$	
Mounting Torque(M6)		-	4.0	N.m	
Terminal Torque(M6)	Typical Including Screws	-	3.0	N.m	
Weight		-	95	g	

Electrical Characteristics @Tc = 25°C(unless otherwise specified)

Characteristics	Conditions	Symbol	Min.	Typ.	Max.	Unit	
Cathode Anode Breakdown Voltage	$I_R=100\mu A$	V_R	400	-	-	V	
Diode Maximum Forward Voltage	$I_F=100A$	V_{FM}	$T_C=25^\circ C$	-	1.0	1.3	V
			$T_C=100^\circ C$	-	0.9	-	
Diode Peak Reverse Recovery Current	$T_C=100^\circ C$, V_{RRM} applied	I_{RRM}	-	-	1.0	mA	
Diode Reverse Recovery Time	$I_F=1A, V_R=30V$ $di/dt = -200A/\mu S$	t_{rr}	-	35	50	ns	
Diode Reverse Recovery Time	$I_F=100A, V_R=200V$ $di/dt = -200A/\mu S$	t_{rr}	$T_C=25^\circ C$	-	60	-	ns
			$T_C=100^\circ C$	-	90	-	

Thermal Characteristics

Characteristics	Conditions	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance(Non-Isolation Type)	Junction to Case	$R_{th(j-c)}$	-	-	0.31	$^\circ C/W$

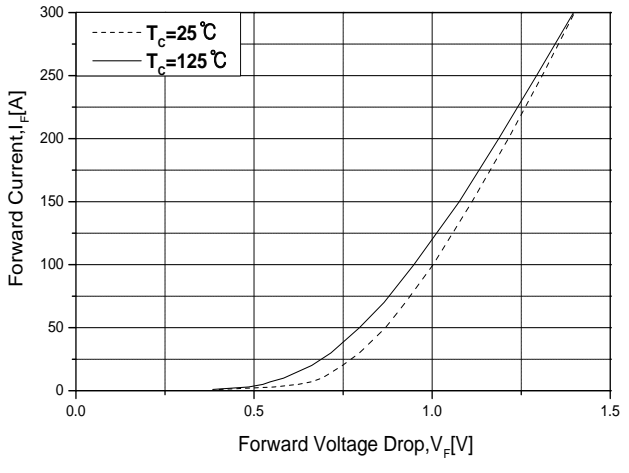


Fig.1 Typical Forward Voltage Drop vs. Instantaneous Forward Current

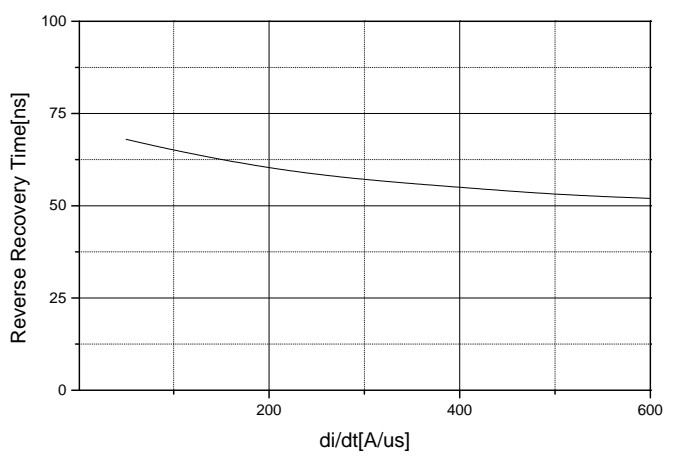


Fig.2 Typical Reverse Recovery Time Vs. $-di/dt$

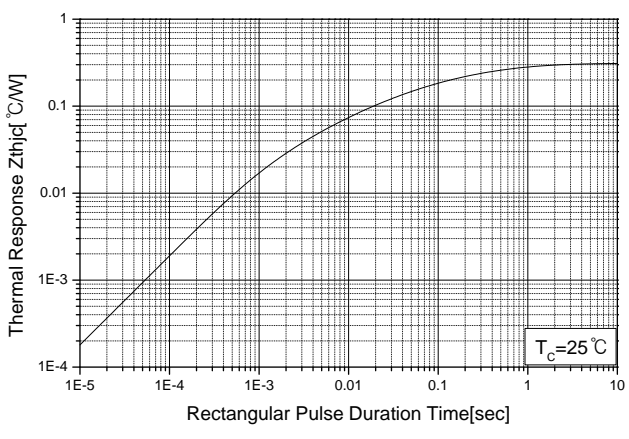


Fig.3 Transient Thermal Impedance (Zthjc) Characteristics

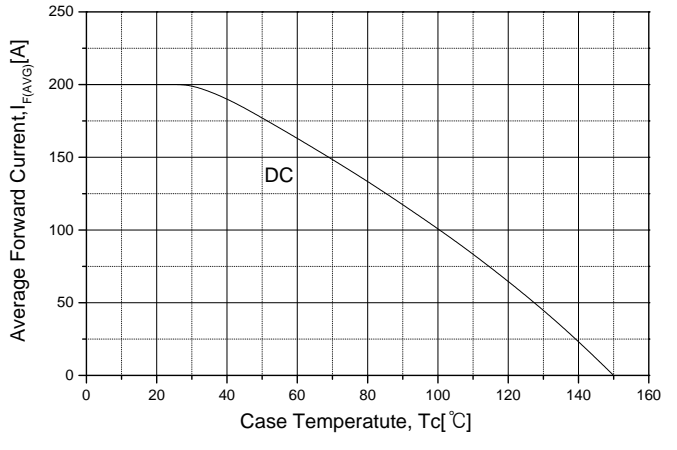
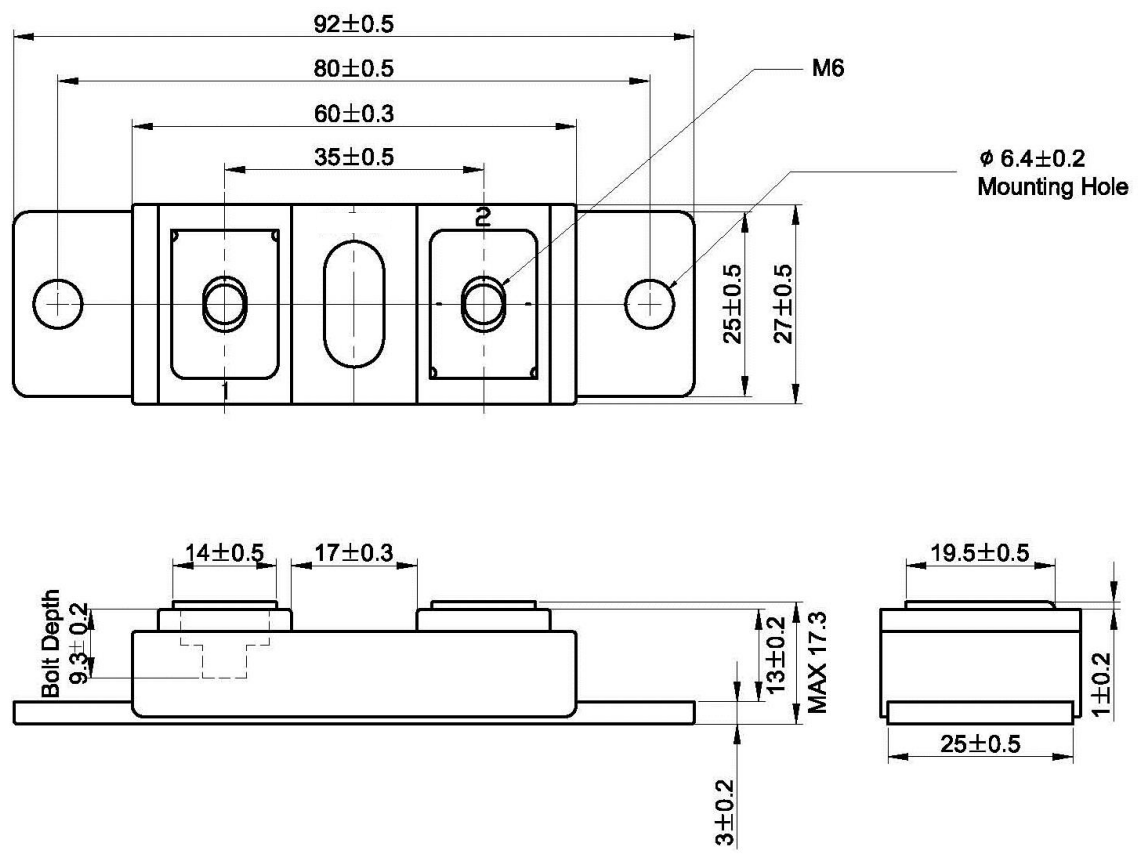


Fig.4 Forward Current Derating Curve

Package Dimension

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Dimensions are in millimeters, unless otherwise specified



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